



General Notification

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Change of NXP Standard Ship Label and the NXP PQ (Product Label) for Packaging

General Information

NXP Semiconductors announces the following changes to the NXP Standard Ship label and the NXP PQ (Product label) for packaging.

The Shipping Label changes will affect current and future customers receiving the NXP Standard Ship Label.

PQ label changes will affect all product shipments. Both the new and the old PQ box labeling will be shipped in parallel for a certain transition period until all finished product inventories are consumed in NXP warehouse stocks.

General Information

Shipping Label Change

The following changes will apply to the NXP Standard Shipping Label.

The new label format will list the following data elements.

- Ship To (Recipient Address)
- Ship From (NXP Location)
- * Purchase Order
- * Customer Product ID (Customer Part Number)
- * Package Count (Carton sequence number/Total Number of Cartons)
- * Qty (Shipping Container Qty)
- * LP NR. (License Plate Number = unique box identifier)

- DEST (Shipper Info)
- ROUTE ID (Shipper Info)
- MPN (Manufacturing Part Number)
- 12NC (Part ID)
- Remarks (Shipper Notes)
- SHT (Ship to NXP Customer Identification)
- TTL (Total inner box count)
- SHD (Ship Date)
- CONT SIZE (NXP Container size)
- G.W (Gross Weight)¿
- N.T (Net Weight)
- Origin + Package Qty
- * Package ID (Delivery Advice Note + Carton Sequence + Total Number of Cartons)
- Halogen Free/PB Free and RoHS Indicators

Note: This new format will not include the MFG Date Code. That information can be found on the intermediate box label inside the shipping container.

(*) bar coded fields.

Reason for Change:

The NXP Standard ship label currently consist of two or more labels (up to 4 labels) depending the number of Origins of the product. This will now be consolidated into one label to eliminate the need for multiple labels placed on the shipping container and it will also allow the recipient to receive product into their facilities with the use of bar-coded information.

General Information

PQ Label Change

The following changes will apply to the NXP PQ Label. The NXP PQ label will be modified to include a bar code for the PUID field.

This field will be coded Full ASCII CODE 39 due to the limitation of Standard Code 39 to read lower case lettering.

The field will also include a data identifier of "33T". No additional changes will be made to the format or current bar coded fields 1P, 9D, Q and 2D bar code. All will remain as it is today.

In case of additional questions please contact scott.mims@nxp.com .

Reason

The PUID (Packing Unit Identifier) is created by the post final test packing operation to identify the Diffusion Batch ID(s) and Assembly Batch ID(s) in the PQ Box.

With the addition of the bar code, customer can scan (using a liner bar code) the PUID into their system of record.

The PUID can then be used for trace product into the ROOTS (Rapid Online Overall Traceability System), NXP centralized Lot-ID trace system.

Additional information

Additional documents: [view online](#)

Remarks

These changes described will have no impact to form, fit or function of the product shipped to customers neither to the marking on the product. NXP will begin shipping product with these label format during WW10 of 2020.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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